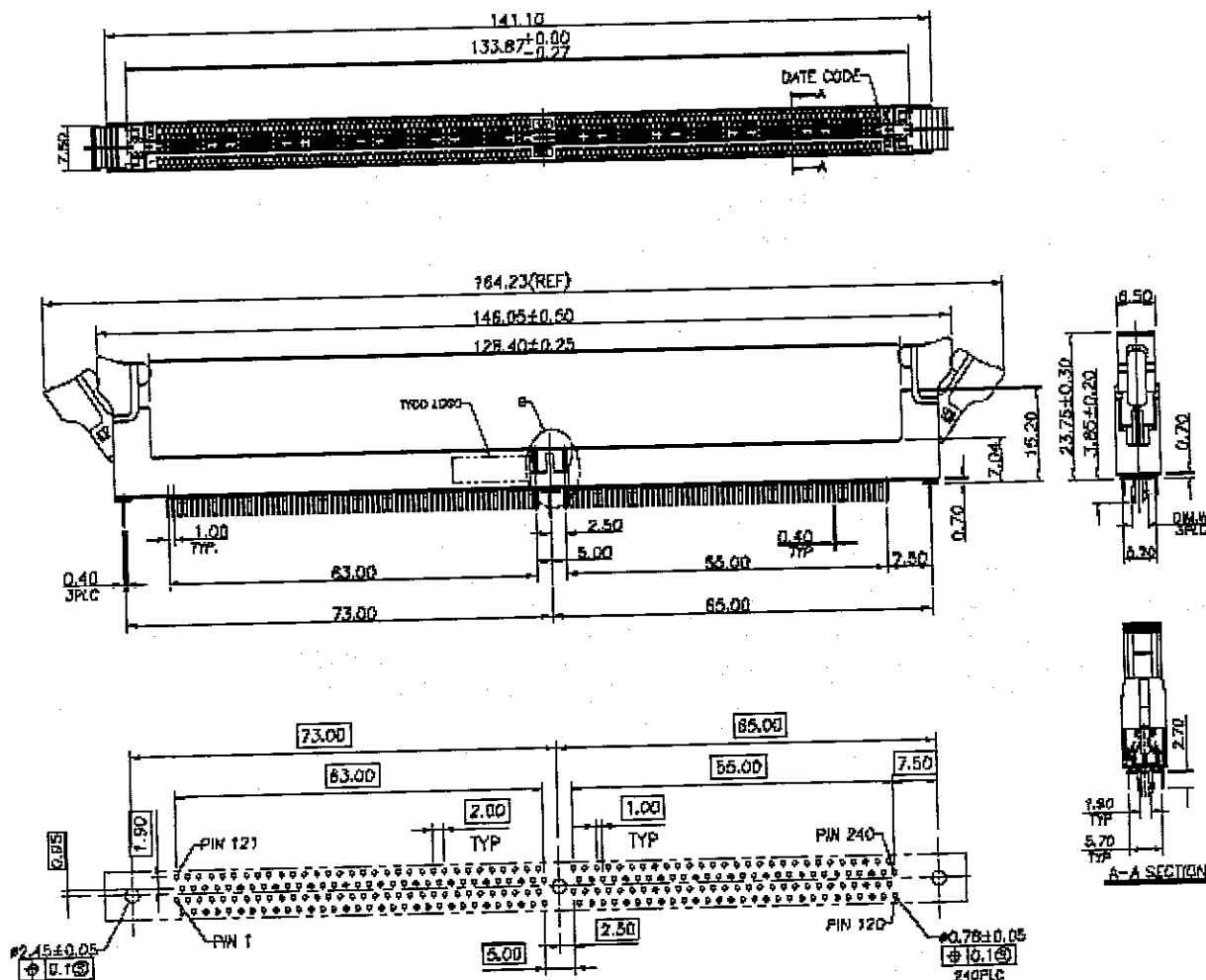


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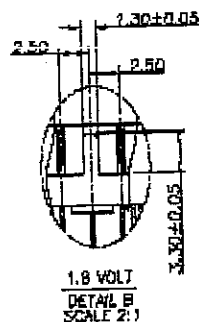
NUMERATIONS IN MILLIMETERS. DO NOT SCALE PRINT.

print: DIST

DW



RECOMMENDED PCB LAYOUT
PCB TOLERANCE: ± 0.05



C	ADDED P/MS-3,5,6,7,8,9-1	EDR-06-027558	HH	SH	220607
B	REVISED	EDR-06-007135	SH	WK	234106
A	REVISED	EDR-06-016182	SH	WK	234607
G	FIRST RELEASED	F200-0028-D4	SH	JC	104610
LTH	REVISION RECORD	EDR	SH	CHK	2004
					DATE

NOTES:

1. MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC, PA46,
UL94V-0, COLOR: SEE TABLE
 - 1.2 EXTRACTOR: THERMOPLASTIC(PA66),
UL94V-0, COLOR: WHITE
 - 1.3 CONTACT: PHOSPHOR BRONZE
 - 1.4 BOARD LOCK: BRASS
2. FINISH:
 - 2.1 CONTACT:
GOLD PLATING ON CONTACT AREA,
2.54 μ m(100 μ ")MIN. MATTE TIN PLATING ON SOLDER TAILS,
1.27 μ m(50 μ ")MIN. NICKEL UNDERPLATING OVERALL.
 - 2.2 BOARD LOCK:
1.27 μ m(50 μ ") MIN NICKEL UNDERPLATING OVERALL.
3. RECOMMENDED PCB THICKNESS: 1.27mm
4. WAVE SOLDERING CAPABLE TO 265 $\pm$ 5°C,
PER TYCO SPEC. 109-202 CONDITION B.

2.90	GREEN/3258C	GOLD FLASH	8-	-1
	BLUE/2548C	GOLD FLASH	7-	-1
	GREEN 347C	15u"	6-	-4
		GOLD FLASH	6-	-3
	PURPLE 2726U	15u"	8-	-2
		GOLD FLASH	6-	-1
BLUE GREEN 338U	15u"	5-	-2	
	GOLD FLASH	5-	-1	
2.65	ORANGE 137C	15u"	4-	-2
		GOLD FLASH	4-	-1
	APPLE GREEN 382U	15u"	3-	-2
		GOLD FLASH	3-	-1
2.90	BLUE 301C	15u"	2-	-2
		GOLD FLASH	2-	-1
	WHITE	15u"	1-	-2
		GOLD FLASH	1-	-1
	BLACK	30u"		-3
		15u"		-2
GOLD FLASH		1734097-1		
DM. W	HSG. COLDF PANTONE	GOLD PLATING	PART NUMBER	

TOLERANCES UNLESS OTHERWISE SPECIFIED		M. HIGASHI 27-NOV-2008		TPOC HOLDING THE PATENT FOR VLSI LTD. TAIWAN BRANCH	
Ø PLD ± 1 PLD ± 0.3 2 PLD ± 0.2 3 PLD ± ANGLES ± 3°		CHK VLSI KE 27-NOV-2008		NAME	
MATERIAL		APVD VLSI KE 27-NOV-2008		DDRII 240PIN SOCKET	
SEE NOTE		PRODUCT SPEC 10B-57350			
FINISH		APPLICATION SPEC -		LOC SEE DW A3	DRAWING NO C-1734097
SEE NOTE		WEIGHT 10 GRAM		SCALE -	SHEET 1 OF 3

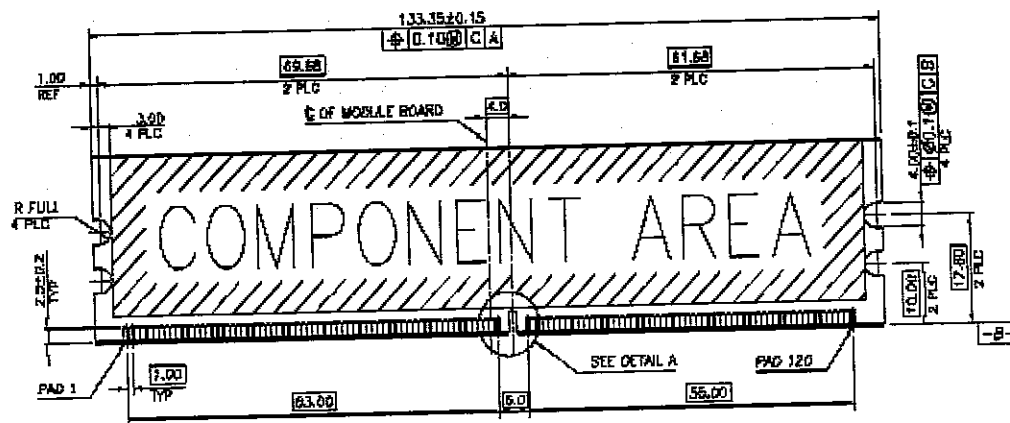
C-1734097

3RD ANGLE PERSPECTIVE

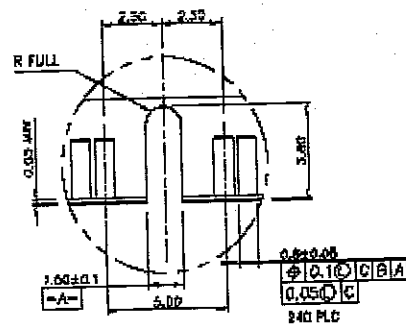
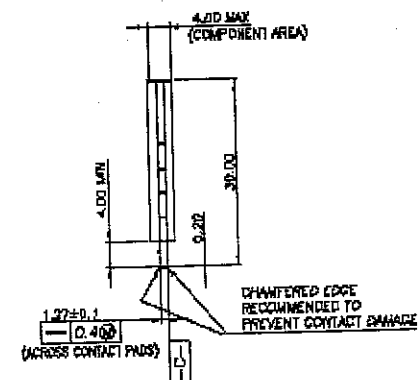
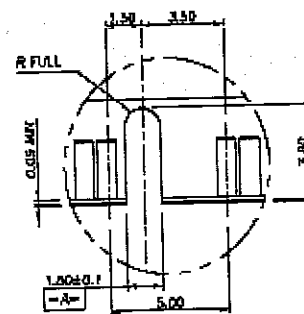
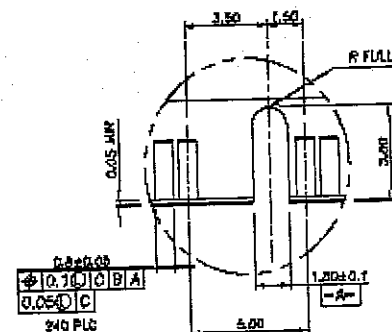
METRIC

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PRINT DW
DATE



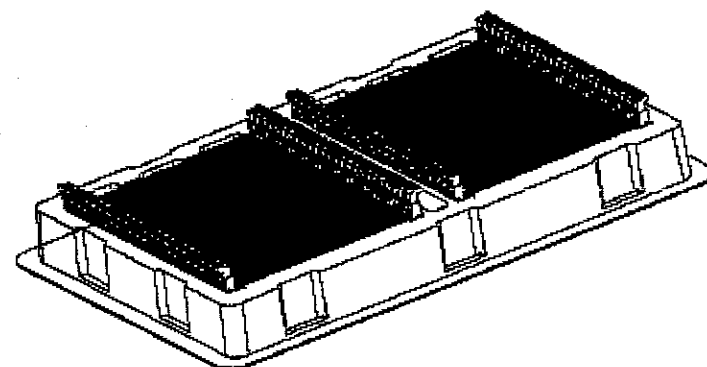
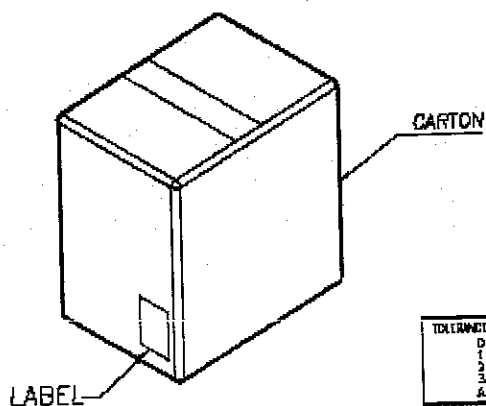
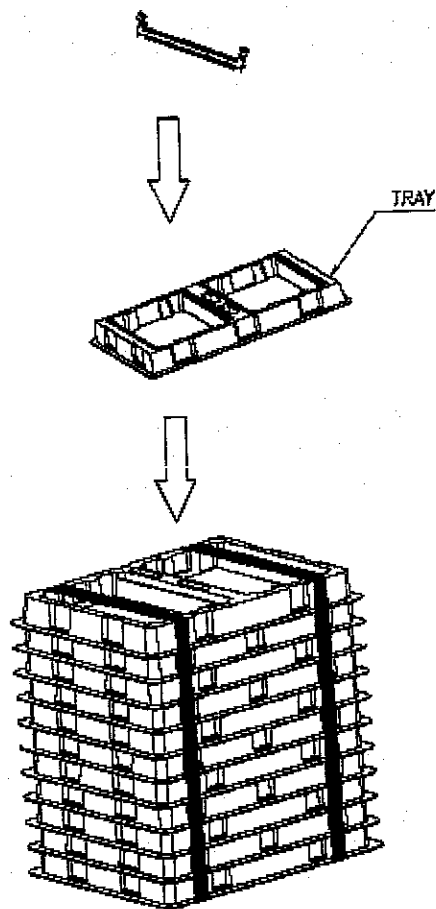
RECOMMENDED MODULE LAYOUT

1.8V
DETAIL A
SCALE 4:12.5V
DETAIL A
SCALE 4:13.3V
DETAIL A
SCALE 4:1

TOLERANCES UNLESS OTHERWISE SPECIFIED:		DESIGN	N. HUANG	TWO HOLDINGS DEPARTMENT VI LTD. TAIWAN BRANCH
0 PLG ± 0.3		CHK	S. HOU	
1 PLG ± 0.3			27-NOV-2009	NAME
2 PLG ± 0.2			27-NOV-2009	
3 PLG ± 0.2				DDRII 240PIN SOCKET
ANGLES ± 3				
MATERIAL		APVD	W. J. KE	LOC (SIZE) DRAWING NO. REV
		PRODUCT SPEC	27-NOV-2009	
FINISH		APPLICATION SPEC		DW A ₃ C-1734097 C
		WEIGHT		SCALE SHEET
				2 OF 3

SEE SHEET 1	ECN	DATE
REVISION RECORD		
LTR		

CUSTOMER DRAWING



TRAY LAYOUT

NOTE:

1. DIMENSION:

TRAY: L = 365, W = 255, H = 33

CARTON: L = 385, W = 270, H = 365

2. QUANTITY:

50 PCS/TRAY

10 TRAYS/CARTON (500 PCS/CARTON)

3. WEIGHT :

NET WEIGHT : 5.0KG

GROSS WEIGHT : 7.0KG

SEE SHEET 1	ECN	DATE
REVISION RECORD		

TOLERANCES UNLESS OTHERWISE SPECIFIED D PCD ± 0.3 1 PCD ± 0.3 2 PCD ± 0.2 3 PCD ± 0.2 ANGLES ± 3°	DESIGN H. HUANG 27-NOV-2009	type Electronics TYOO HOLDINGS (SHENZHEN) VI LTD. TAIWAN BRANCH
	CHK S. HOU 27-NOV-2009	
MATERIAL SEE NOTE	APVD W.J. KE 27-NOV-2009	NAME DDRII 240PIN SOCKET
	PRODUCT SPEC -	
FINISH SEE NOTE	APPLICATION SPEC -	LOC DW A3
	WEIGHT -	
DRAWING NO. C-1734097		REV C
SCALE -		SHEET 3 OF 3

CUSTOMER DRAWING